

Serial No. : 2014-1290

DATE: 2014/11/04

上海大真空国際貿易有限公司

CRYSTAL RESONATOR
DST310S
32. 768kHz
1TJF125DP1AI115

Please acknowledge receipt of this specification by signing and returning a copy to us.

	RECEIPT
DATE	
RECEIVED	(signature)
	(name)

General Manufacturer of Quartz Devices

1389 Shinzaike, Hiraoka-cho, Kakogawa, Hyogo 675-0194 Japan

Phone (81)79–425–3141 Fax (81)79–425–1134 http://www.kds.info/index_en.htm

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1. ELECTRICAL CHARACTERISTICS

(This test shall be performed under the conditions of temp.at +25±3°C,Relative humidity 60%max.)

1.1. NOMINAL FREQUENCY 32.768 kHz

1.2. OVERTONE ORDER Fundamental

1.3. LOADING CAPACITANCE(CL) 12.5 pF

1.4. FREQUENCY TOLERANCE $\pm 20 \times 10^{-6}$ max. (at $\pm 25 \pm 3^{\circ}$ C)

1.5. DRIVE LEVEL 0.2 μ W \pm 20% (1 μ W max.)

1.6. SERIES RESISTANCE 80 $k\Omega$ max. (at Series)

1.7. TURNOVER TEMPERATURE +25 ±5°C

1.8. PARABOLIC COEFFICIENT -0.04×10⁻⁶ / °C² max.

1.9. SHUNT CAPACITANCE 1.3 pF typ.

1.10. OPERATING TEMPERATURE RANGE -40 ~ +85 °C

1.11. STORAGE TEMPERATURE RANGE -40 ~ +85 °C

1.12. INSULATION RESISTANCE 500 M Ω min. (at DC100±15V)

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2. DIMENSIONS AND MARKING

2.1. DIMENSIONS

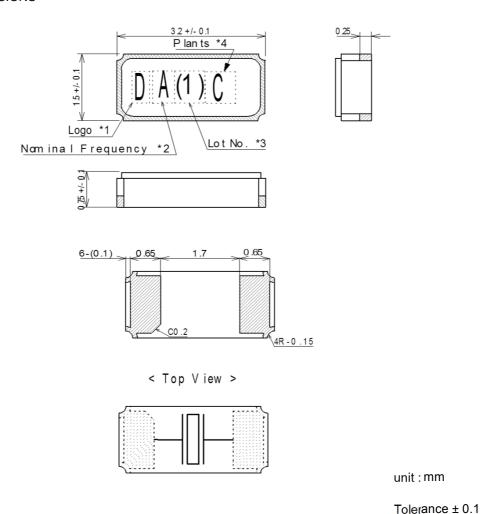


Fig.-1

2.2. MARKING

Marking should be printed as follows:

Logo(*1), Nominal Frequency(*2), Lot No.(*3), Plants(*4)

*1 Manufacturer's trademark shall be marked 'D' as Logo.

*2 In case of 32.768kHz, nominal frequency shall be marked 'A'.

*3 Lot No. shall be marked three figures.

(1) Year: The last digit of the year.

Week:We gave the sequence of week numbers 01(first week) for production date.

There are starting from 1st of Jan.

However, add '0' figure to the first week during the 9th weeks.

The week means are from Sunday to Saturday.

Manufactured day: 2014.11.04 4 45 ex. Year Week

*4 Manufactured in TIANJIN KDS CORP. shall be marked 'C' as Plants.

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3. PACKING

3.1. EMBOSS CARRIER TAPE & REEL

(1)Dimensions of Emboss carrier tape

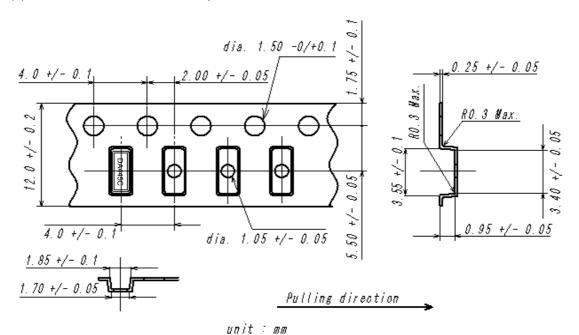
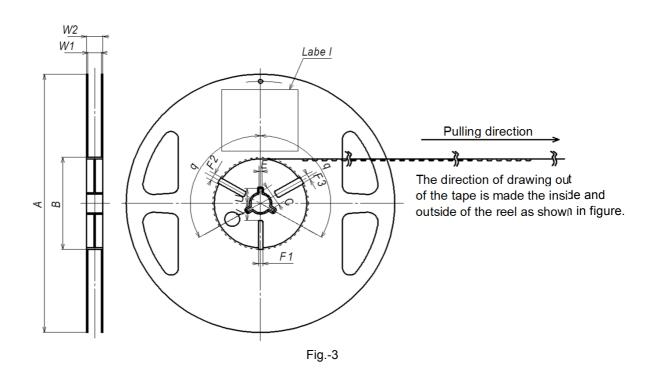


Fig.-2

(2)Dimensions of tape reel



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Table-1

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Item		Mark	Dimensions / Angle	
	Diameter		Α	Ф180 +0 -3.0
Flange	Inside	width	W1	13.0 ± 0.3
	Outside	e width	W2	15.5 ± 1.0
	Out Line	diameter	В	Ф60 +1.0 -0
			F1	3.0 ± 0.2
	Center	Width	F2	4.0 ± 0.2
	core slit		F3	5.0 ± 0.2
Center Core	Center Core	Length	V	11.9
		Position	q	120 °
	Spindle diameter		С	Ф13 ± 0.2
	key Seats	Width	Е	2.0 ± 0.5
		Length	U	10.5 ± 0.4
		Position	q	120 °
	Indication of type		Sticker	label on one side of flange

(3)Storage Condition

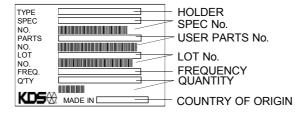
Temperature;+40°C max.,Relative Humidity;80% max. Storage Period:6months max.

(4)Standard packing quantity 3,000pcs./reel for Φ180

(5)Material of the tape

tape	Material
Carrier tape	Polystyrene,Carbon
Cover tape	Polyester

(6)Label Contents



Stick a label on the each reel.

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(7)Taping Dimension

Leader	Cover tape	The length of cover tape in the leader is more than 400mm		
		including empty embossed area.		
	Carrier tape	After all products were packaged, must remain more than		
		twenty pieces or 400mm empty embossed area, which should be sealed		
		by cover tape.		
Terminal	Cover tape	The tip of cover tape shall be fixed temporary by paper		
		tape and roll around the core of reel one round.		
	Carrier tape	The empty embossed area which are sealed by cover tape		
		must remain more than 40mm.		

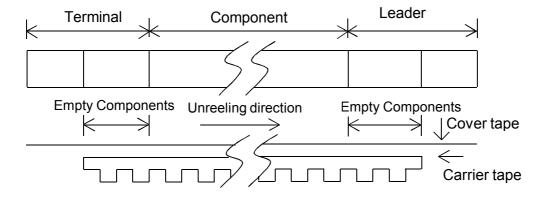


Fig.-4

(8)Joint of tape

The carrier tape and cover tape should not be jointed.

(9)Release strength cover tape

It has between 0.1~0.7N under following condition.

Pulling direction 165~180 ° Speed 300mm/min Otherwise unless specified

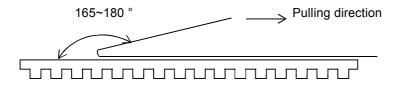


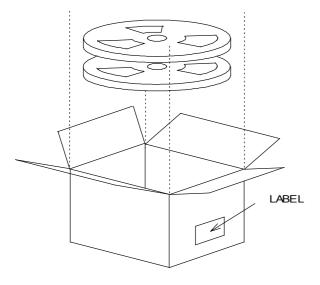
Fig.-5

The component must be free fall, when tear away the cover tape with upside-down the emboss carrier tape.

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3.2. PACKING

(1)The way of packing and label



Label contents
The type of product
Lot No.
Specification
Quantity
Shipment Day
Remark

Fig.-6

(2)The size of packing carton

There may be different size of packing carton used depending on the lot size. Also,the product packed inside shall be protected by air cushion.

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4. REFLOW CONDITIONS (REFERENCE)

During the solder reflow process, please complete within following temperature period. Reflow soldering shall be allowed only 2 times.

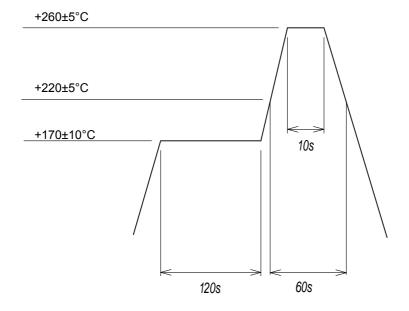
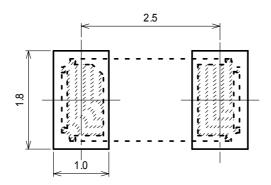


Fig.-7

HANDSOLDERING METHOD

HANDSOLDERING METHOD: +350±10°C,3+1/-0s Each terminal once (Please take care so that a soldering iron should not touch a lid directly.)

5. LAND PATTERN (REFERENCE)



unit:mm

Fig.-8

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6. MECHANICAL ENDURANCE

6.1. SHOCK

After the following test, parts shall conform specification table-2-B. 3times free drop from 75cm heights to hard wood board of minimum thickness 30mm.

6.2. VIBRATION

After the following test, parts shall conform specification table-2-A, and no abnormal appearance shall be observed.

(1)Frequency of Vibration: 10~55Hz 1~2min

(2)Amplitude total : 1.5mm (3)Vibration axis : X,Y,Z

(4) Vibration period : 2h for X,Y,Z axis

6.3. SUBSTRATE BENDING

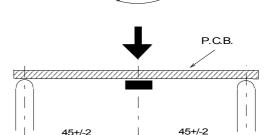
After the following test,parts shall conform specification table-2-A, and no abnormality shall be observed in external appearance and sealing tightnen and others shall be based on ET-7403 of EIAJ.

pressure jig

Mount the specimen on substrate.

Apply the following pressure

Direction : see Fig.-9
Speed : 0.5mm/s
Hours : 5±1s
Amount of substrate: 3mm max.



20

R230

Fig.-9

6.4. SHEAR

After the following test,parts shall conform specification table-2-A, and no abnormality shall be observed in external appearance and sealing tightness and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure

Weight: 10N
Hours: 10±1s
Direction: see Fig.-10

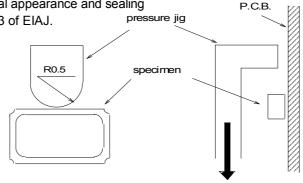


Fig.-10

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6.5. BODY STRENGTH

After the following test, parts shall conform specification table-2-A, and no abnormality shall be observed in external appearance and sealing tightnen and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure

Pressure jig: R0.5
Weight: 10N
Hours: 10±1s
Direction: see Fig.-11

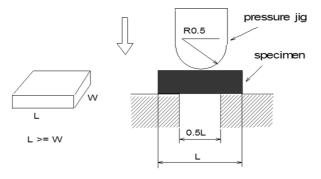


Fig.-11

6.6. SEAL

Less than 2.0×10⁻⁹ Pa*m³/s by Helium leak detector. Also,no bubble is observed by Fluorinert tests.

6.7. SOLDERABILITY

After the following test. More than 90% of lead shall be covered by new solder. $3\pm1s$ dip in $+235\pm5^{\circ}$ C solder. (Use rosin type flux for solder.)

6.8. RESISTANCE TO SOLDERING HEAT (REFLOW)

48h past at room temperature from following test, parts shall conform specification table-2-C. perform the attached reflow conditions to reference.

6.9. RESISTANCE TO SOLDERING HEAT (HAND SOLDERING METHOD)

48h past at room temperature from following test,parts shall conform specification table-2-C. +350±10°C,3+1/-0s Each terminal once

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7. ENVIRONMENTAL ENDURANCE

7.1. HUMIDITY

2h past at room temperature after following test,parts shall conform specification table-2-C. 240h +85±2°C,relative humidity 85±5%.

7.2. LOW TEMPERATURE

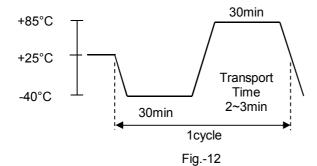
2h past at room temperature after following test,parts shall conform specification table-2-C. 240h -40±3°C

7.3. HIGH TEMPERATURE

2h past at room temperature after following test,parts shall conform specification table-2-C. 240h +85±2°C

7.4. TERMAL SHOCK TEST

2h past at room temperature after 25cycles of following test,parts shall conform specification table-2-C.



8. SPECIFICATION

Table-2

	Frequency Variation	Equivalent Resistance
Α	±5×10 ⁻⁶	±25 % or ±10kΩ max. (Use larger specification)
В	±8×10 ⁻⁶	±25 % or ±10kΩ max. (Use larger specification)
С	±10×10 ⁻⁶	±25 % or ±10kΩ max. (Use larger specification)

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9. THE CAUTIONS ON USE FOR DST310S

9.1. SOLDERING

Please perform reflow conditions within 2 times.

9.2. MOUNT

Crystal products are designed to be compatible with automatic mounting. Be sure to have a mounting test in advance by using the actual mounting machine and check that the characteristics of the products are not damaged by the automatic mounting.

In the process where the boad is warped, such as board separation process, be careful that the warping does not influence the characteristics and soldering of crystal products.

Since mounting by Ultrasonic welding and processing have a possibility of an excessive vibration spreading inside a tuning fork crystal resonator and becoming the cause of characteristic deterioration and not oscillating, it does not recommend.

9.3. WASHING

About use of the washing liquid of a basin system, an alcoholic system, and a chlorofluorocarbon-replacing material system, it is checking that it is satisfactory.

However please consult in advance about other washing liquid.

Tuning fork crystal resonators should not have ultrasonic washing because their frequency band is close to the washing frequency band of ultrasonic washing machines, very probably causing resonance destruction. To use ultrasonic washing to clean these resonators, tests must be performed in advance under actual application conditions.

9.4. DRIVE LEVEL

The piece of crystal it is processed very smaller than the conventional thing inside DST310S series crystal unit may be damaged, if crystal resonators are exposed to an excessively high drive level. Please use the products within the limits specified in the catalogs and specifications.

9.5. HANDLING OF A PRODUCT

DST310S series has sufficient intensity to fall and vibration. Crystal resonators should not have pattern to avoid causing base crack.

9.6. STORAGE

Since the solderability of pins may deteriorate, please avoid storage in high-temperature, high-humidity place. Please store crystal products in a place free from direct sunlight and condensation.

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2014-1290 REVISION RECORD

Rev.No	Date	Reason	Contents	Approved	Checked	Drawn
-	2014/11/04	-	The first edition.	T.Kusai	T.Fujii	H.Nasu
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